LoRa Module RAK811 Datasheet V1.1

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1. General Description

RAK811 Low-Power Long Range LoRa Technology Transceiver module, provides an easy to use, small size, low-power solution for long range wireless data transmission.

First, The RAK811 module complies with the latest LoRaWAN Class A & C protocol specifications, it is simple to access LWPA IOT platforms, such Actility etc. Second, it also support Lora Point to Point communications, this function can help customers implement their own private long range Lora network fast.

Module integrates semtech SX1276 and stm32L, offer user an serials At commands with UART Interface .It is easy to accomplish their applications, such as simple long range sensor data applications with external host MCU, low-power feature is suitable for battery applications.

This compact module is a total solution which developing of LORA-wan protocol techniques. The module's applications as following:

- 1. Automated Meters Reading
- 2. Home and Building Automation
- 3. Wireless Alarm and Security Systems
- 4. Industrial Monitoring and Control
- 5. Long Range Irrigation Systems

2. Features

- ➤ Long Range LoraWAN operating in the 863 MHz 928 MHz frequency bands
 - FCC Frequency range 902MHZ~928MHZ
 CE Frequency range 863MHZ~870MHZ
 MIC Frequency range 921MHZ~927MHZ
 KCC Frequency range 920MHZ~923MHZ
- ➤ Lora Point to Point communication in the 860MHz-1020MHz frequency
- > Small size and low power
- > High Receiver Sensitivity: down to -146 dBm
- > FSK, GFSK, and LoRa Technology modulation
- ➤ IIP3 = -11 dBm
- > Up to 15 km coverage at suburban and up to 5 km coverage at urban area

3. System Block Diagram

The block diagram of module is depicted in the figure below.

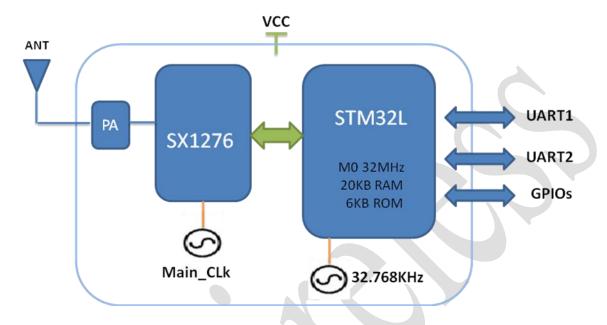


Figure 3-1 System Diagram

4. Hardware Description

4.1 Pin Outline

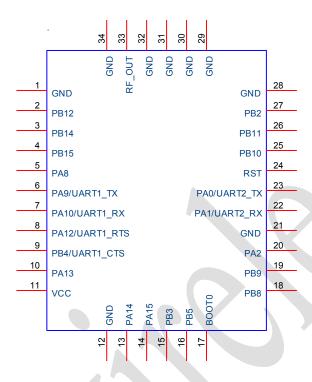


Figure 4-1 Module Pin outline

4.2 Pin definition

Table 4-1: Pin Definition

NO	Name	Type	Description
1	GND		Ground connections
2	PB12	I/O	B part for GPIO port
3	PB14	I/O	B part for GPIO port
4	PB15	I/O	B part for GPIO port
5	PA8	I/O	A part for GPIO port
6	PA9/UART1_TX	О	UART1 Interface
7	PA10/UART1_RX	I	UART1 Interface
8	PA12/UART1_RTS	О	UART1 Interface
9	PB4/UART1_CTS	I	UART1 Interface
10	PA13	I/O	A part for GPIO port
11	VCC	P	Main power voltage source input
12	GND	_	Ground connections

PA14	I/O	A part for GPIO port
PA15	I/O	A part for GPIO port
PB3	I/O	B part for GPIO port
PB5	I/O	B part for GPIO port
ВООТ0	I	Boot mode GPIO enable pin
PB8	I/O	B part for GPIO port
PB9	I/O	B part for GPIO port
PA2	I/O	A part for GPIO port
GND	_	Ground connections
PA1/UART2_RX	I	UART2 Interface
PA0/UART2_TX	О	UART2 Interface
RST	I	Reset trigger input
PB10	I/O	B part for GPIO port
PB11	I/O	B part for GPIO port
PB2	I/O	B part for GPIO port
GND	_	Ground connections
GND	-	Ground connections
GND	_	Ground connections
GND	_	Ground connections
GND	_	Ground connections
RF_OUT	I/O	RF I/O port
GND	_	Ground connections
	PA15 PB3 PB5 BOOT0 PB8 PB9 PA2 GND PA1/UART2_RX PA0/UART2_TX RST PB10 PB11 PB2 GND	PA15 I/O PB3 I/O PB5 I/O BOOTO I PB8 I/O PB9 I/O PA2 I/O GND — PA1/UART2_RX I PA0/UART2_TX O RST I PB10 I/O PB2 I/O GND —

4.3 Physical Dimensions

(Unit: mm)

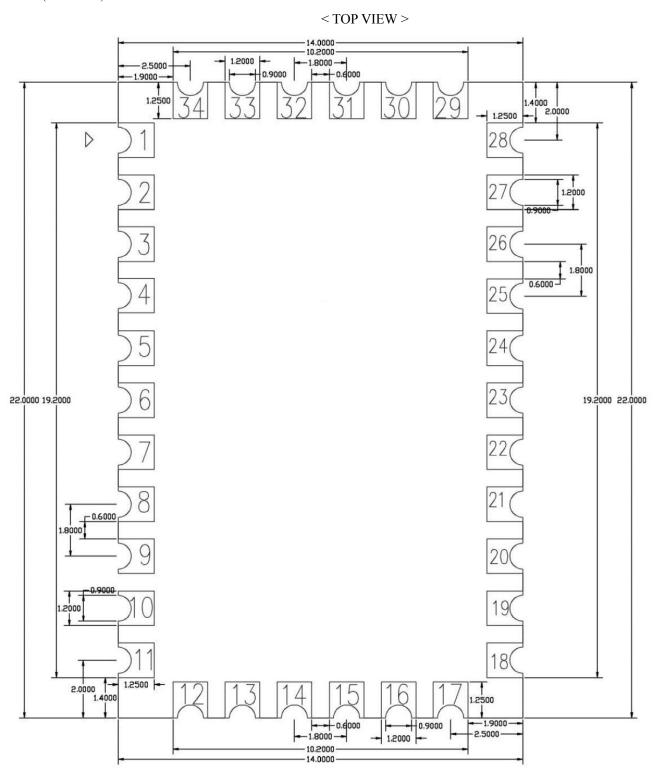


Figure 4-2 Module dimensions

5. General Specification

5.1 General specification

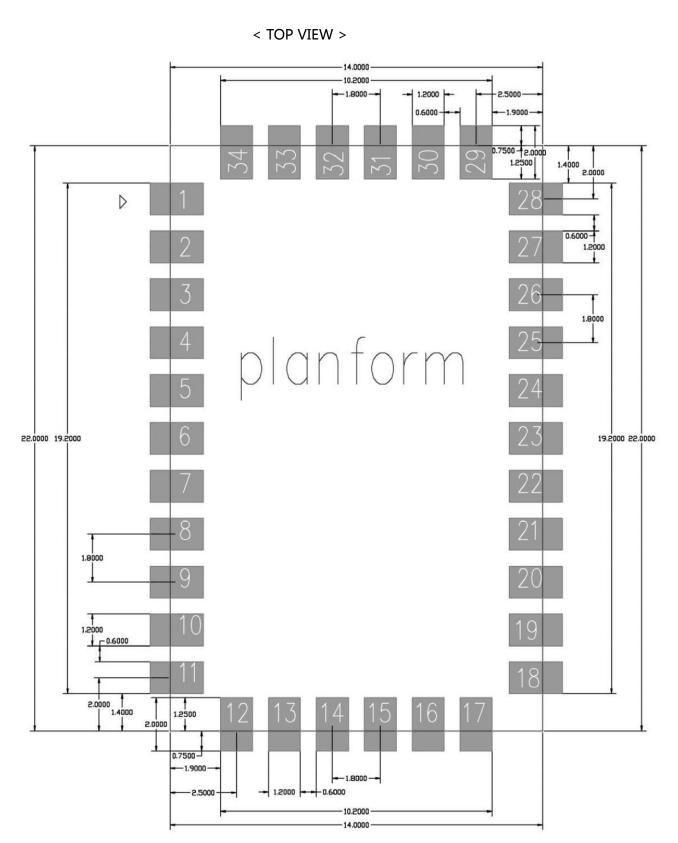
Model Name	RAK811
Dimension	L x W x H: 22 x 14 x 1.7 mm
Interface	UART1, UART2, GPIOs
Operating temperature	-40°C to 85°C
Storage temperature	-40°C to 85°C

5.2 Recommended Operating Rating

	Min.	Тур.	Max.	Unit
Operating Temperature	-40	25	85	deg.C
VCC	3.15	3.3	3.45	V

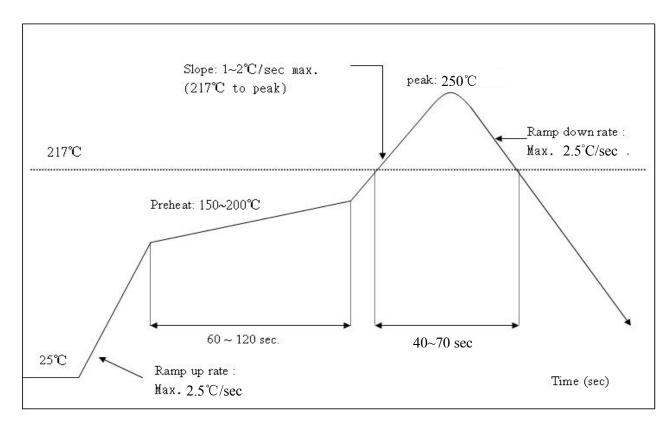
6. Layout Recommendation

(Unit: mm)



7. Recommended Reflow Profile

Referred to IPC/JEDEC standard. Peak Temperature : $<250^{\circ}$ C Number of Times : ≤ 2 times





8. Order Information



RAK (211-170504

FCC ID: 2AF6B-RAKSMR006







FCC Caution

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment. This device complies with part 15 of the FCC Rules. Operation is subject to the

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Radiation Exposure Statement

following two conditions:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

This module is intended for OEM integrator. The OEM integrator is still responsible for the FCC compliance requirement of the end product, which integrates this module. The final end product must be labeled in a visible area with the following" Contains FCC ID: 2AF6B-RAKSMR006" and the frequency can't be changed by end users.

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9. Contact information

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10. Change Note

Version	Date	Change
V1.0	2016-06-11	Draft
V1.1	2016-11-15	Add LoraP2P mode

